

SPECIFICATIONS FOR CHIP LED

MODEL: [WR-PB1608G/C](#)

| | | | |
|---------------|--------------|-------------|-------------|
| Part No. | WR-PB1608G/C | | |
| Emitted Color | Yellow Green | Len's Color | Water Clear |
| Chip Material | GaP | | |

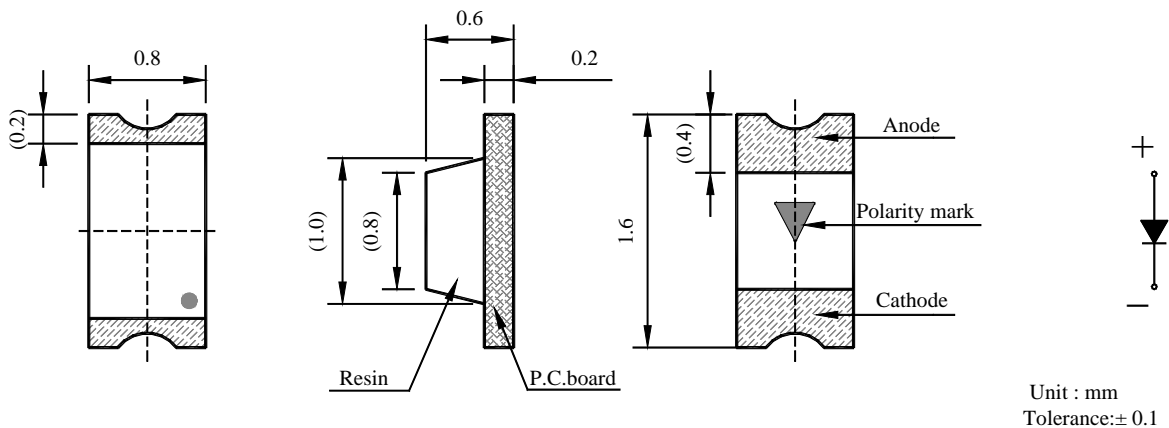
Features:

- Compatible with automatic placement equipment
- Compatible with reflow solder process
- Low power consumption and wide viewing angle
- This product doesn't contain restriction Substance, comply ROHS standard.

Applications:

- Automotive and Telecommunication
- Flat backlight for LCD ,switch and symbol in telephone and fax
- General use for indicators

Package Dimensions:



Electrodes: Au Plating
 Encapsulating Resin: Epoxy Resin
 Package: BT Resin

Absolute Maximum Rating (Ta=25)

| Parameter | Symbol | Max. | Unit |
|---|-----------------|-----------|------|
| Power Dissipation | P _M | 60 | Mw |
| Pulse Forward Current (1/10 duty and 1mec width) | I _{FP} | 60 | mA |
| DC Forward Current | I _F | 20 | mA |
| Reverse Voltage | V _R | 5 | V |
| Operating Temperature Range | Topr | -20 ~ 85 | |
| Storage Temperature Range | Tstg | -30 ~ 100 | |

Electrical Optical Characteristics (Ta=25)

| Parameter | Symbol | Typ. | Max. | Unit | Test Condition |
|--------------------------|----------------|------|------|------|----------------------|
| Luminous Intensity | I _V | 30 | -- | mcd | I _F =10mA |
| Forward Voltage | V _F | 2.1 | 2.5 | V | I _F =10mA |
| Reverse Current | I _R | -- | 10 | uA | V _R =5V |
| Dominant Wavelength | d | 570 | -- | nm | I _F =10mA |
| Spectral Line Half Width | | 30 | -- | nm | I _F =10mA |
| Viewing Angle | 2 1/2 | 125 | -- | Deg. | I _F =10mA |

Parameter Classification

| Forward Voltage (I _F =10mA) | | Dominant Wavelength (I _F =10mA) | | Luminous Intensity (I _F =10mA) | |
|---|-----------|---|-----------|--|---------|
| Code | Min~Max | Code | Min~Max | Code | Min~Max |
| H | 2.0 ~ 2.1 | J | 568 ~ 570 | G | 27 ~ 35 |
| | | | | | |

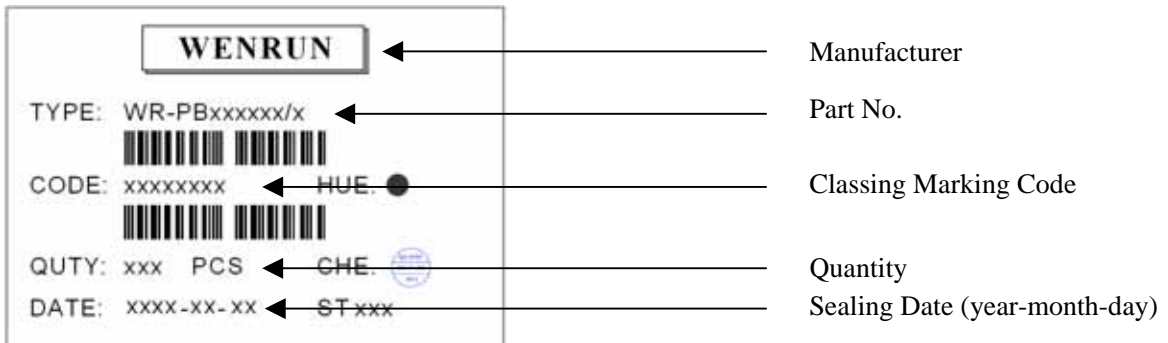
Classing Marking:

For example :

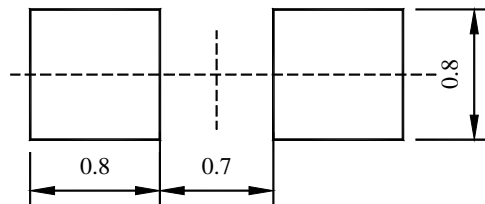
007TPOOR

Code Order : Chip code—Voltage—Dominant Wavelength—OO—Luminous Intensity

Package Label:



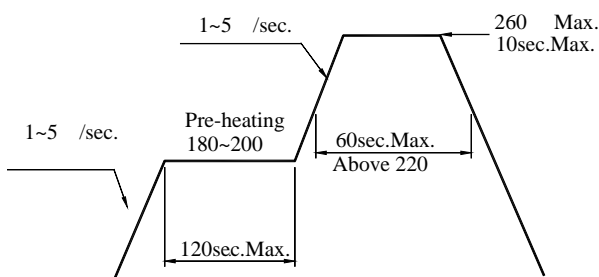
Soldering Pad Dimensions:



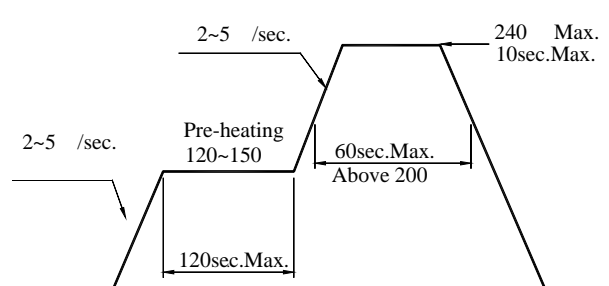
Soldering Conditions (Maximum allowable soldering conditions)

1、 Reflow soldering profile

<Lead-free solder>



<Lead solder>

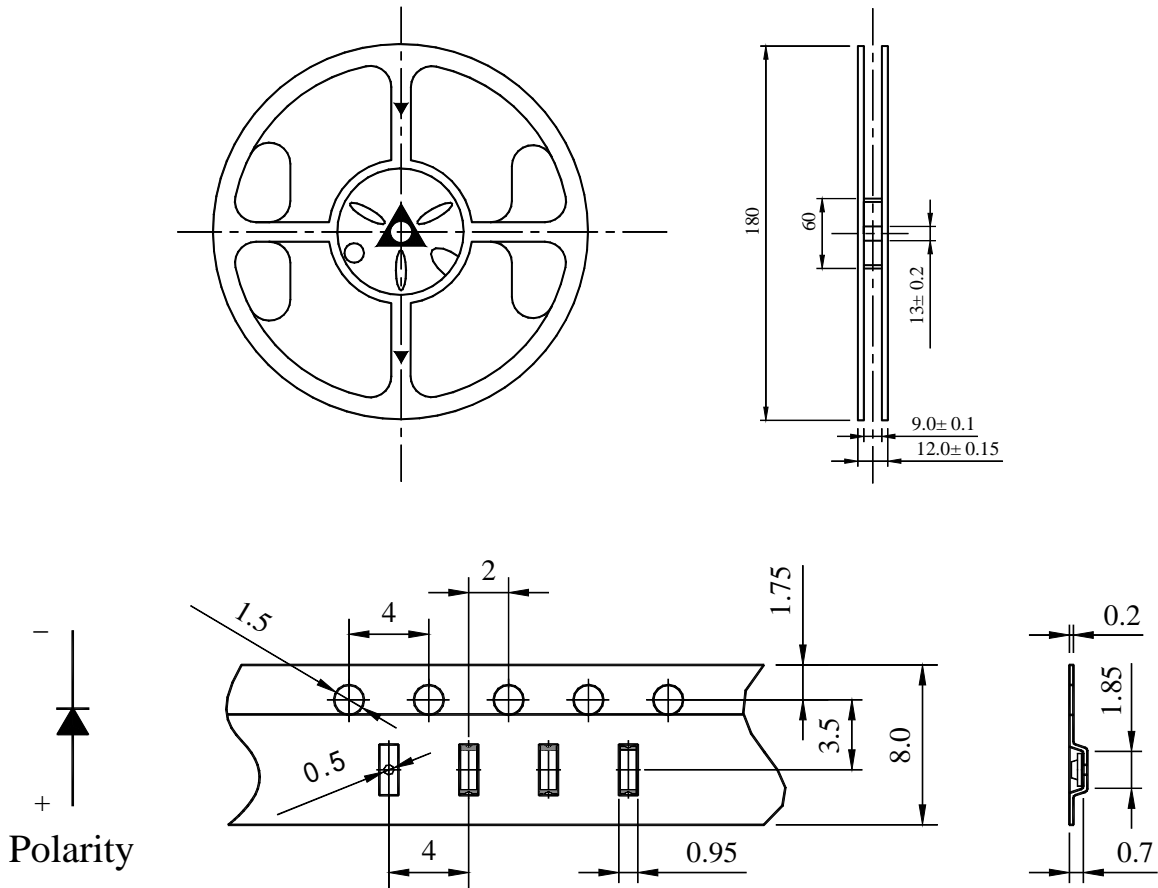


2、 Soldering Iron

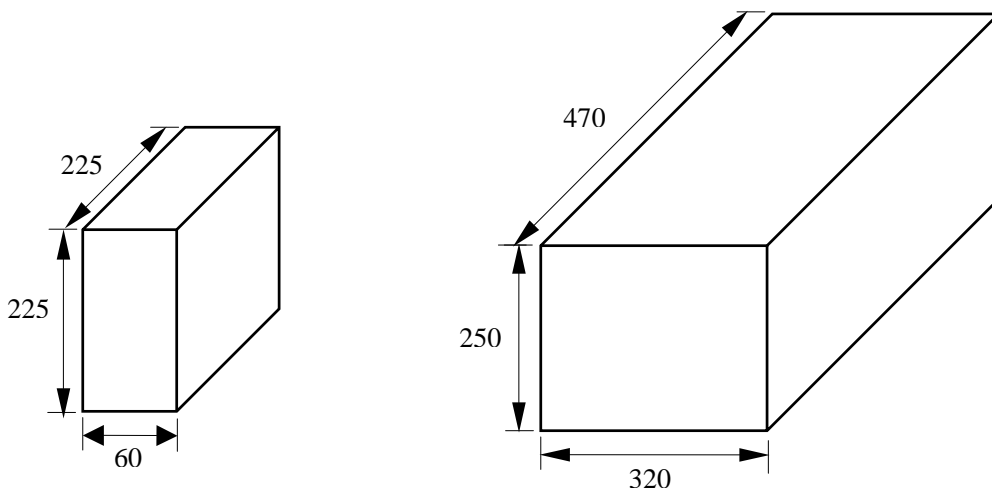
Power dissipation of Iron should be smaller than 25W, and temperature should be controllable. The work must be finished within 3sec under 320 °C, only once.

- Do not stress its resin while soldering.
- After soldering, do not warp the circuit board.
- Pay attention to electrostatic (ESD).

Package Tape Specifications: (4000 pcs/Reel)



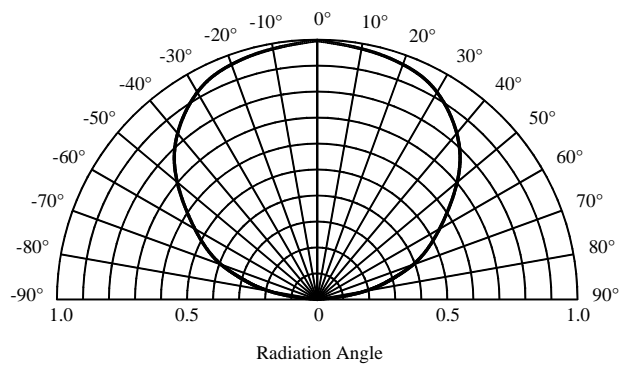
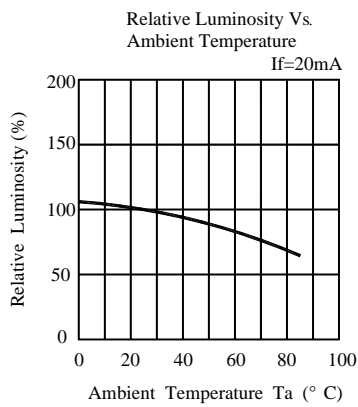
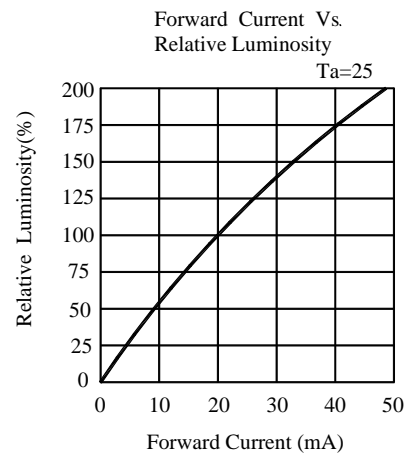
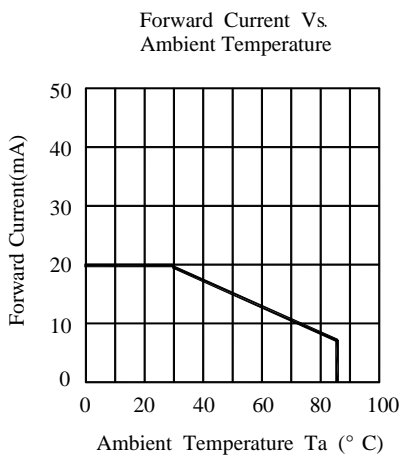
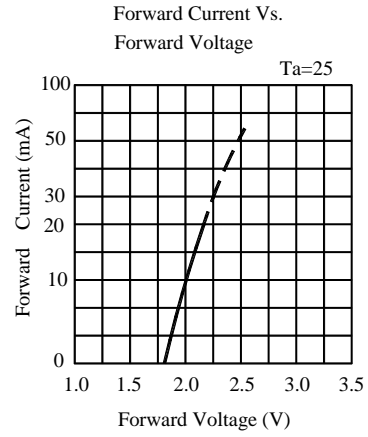
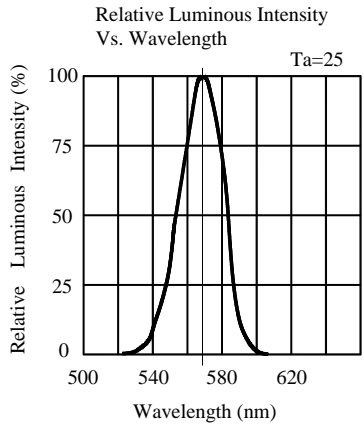
Reel Lead Min.60mm No LEDs



5 Reel in one Box

10 Box in one Carton

Typical Electro-Optical Characteristics Curves :



Reliability Test Items and Conditions

| NO | Test Item | Test Conditions | Duration | Sample | Ac/Re |
|----|----------------------|--|-----------|--------|-------|
| 1 | Temperature Cycle | -30 ~ 25 ~ 100 ~ 25 30min 5min 30min 5min | 50cycles | 100 | 0/1 |
| 2 | High Temp. Storage | Ta=100 | 1000hours | 100 | 0/1 |
| 3 | Temp.& Humidity Test | Ta=85 RH=85% | 1000hours | 100 | 0/1 |
| 4 | Low Temp. Storage | Ta=-30 | 1000hours | 100 | 0/1 |
| 5 | Operating Life Test | Ta=25 ± 5 DC IF=15mA | 1000hours | 100 | 0/1 |
| 6 | Solder Heat | Tsol=260 ± 5 , 10s | 1times | 20 | 0/1 |

Cautions

1、Package

When moisture is absorbed into the package it may vaporize and expand during soldering. There is a possibility that this can cause exfoliation of the contacts and damage to the optical characteristics of the LEDs. So the moisture proof package is used to keep moisture to a minimum in the package.

2、Storage

Before opening the package: The LEDs should be kept at 5~30°C and 60%RH or less. The LEDs should be used within a year.

After opening the package: The LED must be used within 24 hours, else should be kept at 5~30 and 30% RH or less. The LEDs should be used within 7days after opening the package. If unused LEDs remain, they should be stored in moisture proof packages, recommended to return the LEDs to the original moisture proof bag and to reseal the moisture proof bag again.

If the LEDs have exceeded the storage time, baking treatment should be performed more than 12 hours at 60 ± 5°C.

3、The LED electrode sections are comprised of a gold plated. The gold surface may be affected by environments which contain corrosive gases and so on. Please avoid conditions which may cause the LED to corrode or discolor. This corrosion or discoloration may cause difficulty during soldering operations. It is recommended that the User use the LEDs as soon as possible.

4、Please avoid rapid transitions in ambient temperature, especially in high humidity environments where condensation can occur.

Notes:

1、Above specification may be changed without notice. We will reserve authority on material change for above specification.

2、When using this product, please observe the absolute maximum ratings and the instructions for the specification sheets. We assume no responsibility for any damage resulting from use of the product which does not comply with the instructions included in the specification sheets.